



N-Channel 100 V (D-S) 175 °C MOSFET

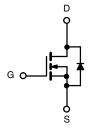
| PRODUCT : | RODUCT SUMMARY | | |
|---------------------|----------------------------------|--------------------|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | |
| 100 | 0.0165 at V _{GS} = 10 V | 60 | |
| 100 | 0.0190 at V _{GS} = 6 V | 56 | |

FEATURES

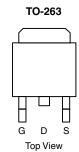
- TrenchFET® Power MOSFETS
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- PWM Optimized for Fast Switching
- 100 % R_a and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- · Isolated DC/DC converters
 - Primary-Side Switch



N-Channel MOSFET



Ordering Information: SUM60N10-17-E3 (Lead (Pb)-free)

| ABSOLUTE MAXIMUM RATINGS | $T_C = 25 ^{\circ}C$, unless otl | nerwise noted) | | |
|---|-------------------------------------|-----------------------------------|------------------|------|
| Parameter | | Symbol | Limit | Unit |
| Drain-Source Voltage | | V _{DS} | 100 | V |
| Gate-Source Voltage | | V _{GS} | ± 20 | v |
| Continuous Drain Current (T _{.I} = 175 °C) | T _C = 25 °C | L | 60 ^a | |
| Continuous Diam Current (1) = 175 C) | T _C = 125 °C | ⊢ I _D ⊢ | 34 ^a | A |
| Pulsed Drain Current | <u>.</u> | I _{DM} | 100 | 7 ^ |
| Avalanche Current | | I _{AS} | 40 | |
| Single Pulse Avalanche Energy ^b | L = 0.1 mH | E _{AS} | 80 | mJ |
| M h | T _C = 25 °C | В | 150 ^c | 10/ |
| Maximum Power Dissipation ^b | T _A = 25 °C ^d | $ P_D$ | 3.75 | W |
| Operating Junction and Storage Temperature Ra | nge | T _J , T _{stg} | - 55 to 175 | °C |

| THERMAL RESISTANCE RATINGS | 3 | | | |
|----------------------------|---------------------------------|-------------------|-------|------|
| Parameter | | Symbol | Limit | Unit |
| Junction-to-Ambient | PCB Mount (TO-263) ^d | R _{thJA} | 40 | °C/W |
| Junction-to-Case (Drain) | | R _{thJC} | 1.0 | C/VV |

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.
- d. When mounted on 1" square PCB (FR-4 material).

Document Number: 72070 S12-0335-Rev. C, 13-Feb-12

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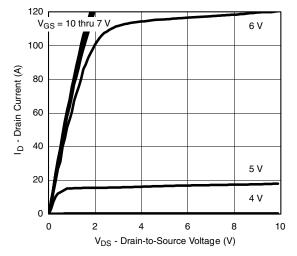
| SPECIFICATIONS (T _J = 25 | °C, unless o | otherwise noted) | | | | |
|---|----------------------|---|------|----------|--------|------|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
| Static | • | | • | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{DS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 100 | | | V |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 2 | | 4 | V |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| | | V _{DS} = 80 V, V _{GS} = 0 V | | | 1 | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ | | | 50 | μΑ |
| | | $V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$ | | | 250 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 100 | | | Α |
| | | V _{GS} = 10 V, I _D = 30 A | | 0.013 | 0.0165 | |
| Duals Course On Olate Desistance | _B | $V_{GS} = 6 \text{ V}, I_D = 20 \text{ A}$ | | 0.015 | 0.019 | 0 |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C | | | 0.031 | Ω |
| | | $V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 175 ^{\circ}\text{C}$ | | | 0.041 | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 30 A | 25 | | | S |
| Dynamic ^b | • | | | • | | |
| Input Capacitance | C _{iss} | | | 4300 | | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 450 | | pF |
| Reverse Transfer Capacitance | C _{rss} | | | 175 | | |
| Total Gate Charge ^c | Qg | | | 65 | 100 | |
| Gate-Source Charge ^c | Q_{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 60 \text{ A}$ | | 25 | | nC |
| Gate-Drain Charge ^c | Q_{gd} | | | 19 | | |
| Gate Resistance | R_{g} | f = 1 MHz | 0.3 | 1.5 | 3 | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | | | 15 | | |
| Rise Time ^c | t _r | V_{DD} = 50 V, R_L = 1.5 Ω | | 12 | 20 | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D\cong 60$ A, V_{GEN} = 10 V, R_G = 2.5 Ω | | 30 | 45 | ns |
| Fall Time ^c | t _f | | | 10 | 15 | |
| Source-Drain Diode Ratings and Cha | aracteristics (| T _C = 25 °C) ^b | 1 | <u>'</u> | | |
| Continuous Current | I _S | | | | 60 | ۸ |
| Pulsed Current | I _{SM} | | | | 100 | Α |
| Forward Voltage ^a | V_{SD} | $I_F = 30 \text{ A}, V_{GS} = 0 \text{ V}$ | | 1.0 | 1.5 | V |
| Reverse Recovery Time | t _{rr} | | | 125 | 200 | ns |
| Peak Reverse Recovery Current | I _{RM(REC)} | $I_F = 50 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$ | | 8 | 12 | Α |
| Reverse Recovery Charge | Q _{rr} | | | 0.5 | 1.2 | μC |

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

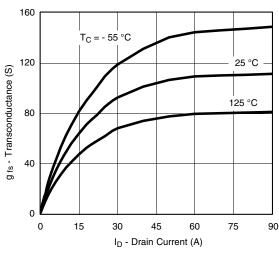
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



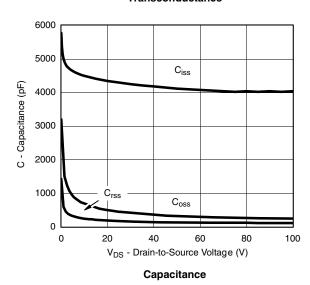
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

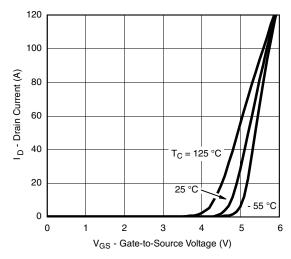


Output Characteristics

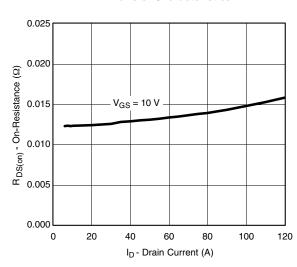


Transconductance

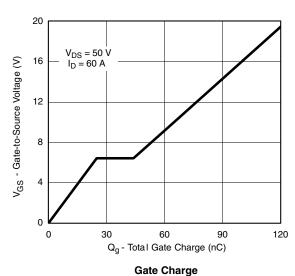




Transfer Characteristics

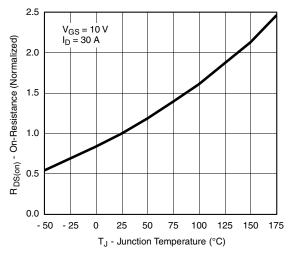


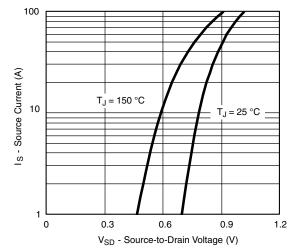
On-Resistance vs. Drain Current



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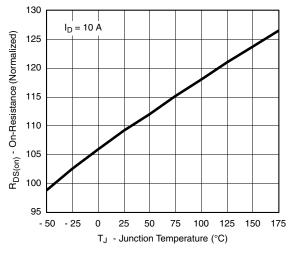
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





On-Resistance vs. Junction Temperature

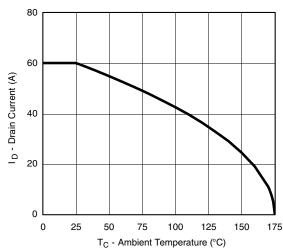
Source-Drain Diode Forward Voltage

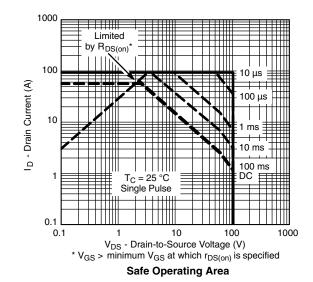


On-Resistance vs. Junction Temperature

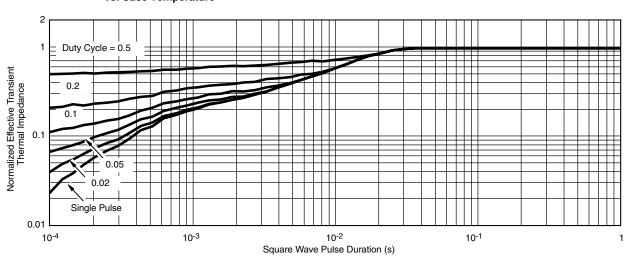


THERMAL RATINGS





Maximum Avalanche and Drain Current vs. Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

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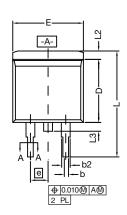
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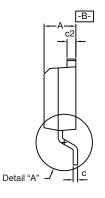
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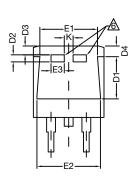


TO-263 (D²PAK): 3-LEAD

VERSION 1: FACILITY CODE = T

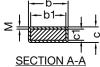








DETAIL A (ROTATED 90°)



| ≥ <u>↓</u> | | | ţ |
|------------|-------|----|---|
| < T | | 10 | ပ |
| SF | CTION | 1 | 1 |

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

| | | INC | HES | MILLIN | METERS |
|----|------------|-----------|-------|--------|--------|
| | DIM. | MIN. | MAX. | MIN. | MAX. |
| | Α | 0.160 | 0.190 | 4.064 | 4.826 |
| b | | 0.020 | 0.039 | 0.508 | 0.990 |
| | b1 | 0.020 | 0.035 | 0.508 | 0.889 |
| | b2 | 0.045 | 0.055 | 1.143 | 1.397 |
| c* | Thin lead | 0.013 | 0.018 | 0.330 | 0.457 |
| ١ | Thick lead | 0.023 | 0.028 | 0.584 | 0.711 |
| c1 | Thin lead | 0.013 | 0.017 | 0.330 | 0.431 |
| Ü | Thick lead | 0.023 | 0.027 | 0.584 | 0.685 |
| | c2 | 0.045 | 0.055 | 1.143 | 1.397 |
| | D | 0.340 | 0.380 | 8.636 | 9.652 |
| | D1 | 0.220 | 0.240 | 5.588 | 6.096 |
| | D2 | 0.038 | 0.042 | 0.965 | 1.067 |
| | D3 | 0.045 | 0.055 | 1.143 | 1.397 |
| | D4 | 0.044 | 0.052 | 1.118 | 1.321 |
| | E | 0.380 | 0.410 | 9.652 | 10.414 |
| | E1 | 0.245 | - | 6.223 | - |
| | E2 | 0.355 | 0.375 | 9.017 | 9.525 |
| | E3 | 0.072 | 0.078 | 1.829 | 1.981 |
| | е | 0.100 BSC | | 2.54 | BSC |
| | K | 0.045 | 0.055 | 1.143 | 1.397 |
| | L | 0.575 | 0.625 | 14.605 | 15.875 |
| | L1 | 0.090 | 0.110 | 2.286 | 2.794 |
| | L2 | 0.040 | 0.055 | 1.016 | 1.397 |
| | L3 | 0.050 | 0.070 | 1.270 | 1.778 |
| | L4 | 0.010 | BSC | 0.254 | BSC |
| | М | - | 0.002 | - | 0.050 |

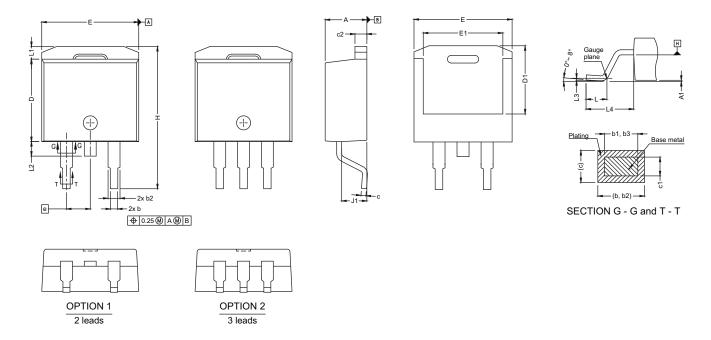
Revison: 28-Oct-2024 Document Number: 71198



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VERSION 2: FACILITY CODE = N



| DIM. | MIN. | MAX. |
|------|-------|--------|
| A | 4.36 | 4.56 |
| A1 | 0 | 0.25 |
| b | 0.70 | 0.90 |
| b1 | 0.51 | 0.89 |
| b2 | 1.20 | 1.46 |
| b3 | 1.17 | 1.37 |
| С | 0.38 | 0.694 |
| c1 | 0.38 | 0.534 |
| c2 | 1.19 | 1.34 |
| D | 8.60 | 9.00 |
| D1 | 6.9 | 7.5 |
| E | 10.15 | 10.55 |
| E1 | 8.1 | 8.7 |
| е | 2.54 | BSC |
| Н | 15.0 | 15.6 |
| L | 1.9 | 2.5 |
| L1 | - | 1.65 |
| L2 | - | 1.78 |
| L3 | 0.25 | 5 typ. |
| L4 | 4.78 | 5.28 |
| J1 | 2.56 | 2.96 |

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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